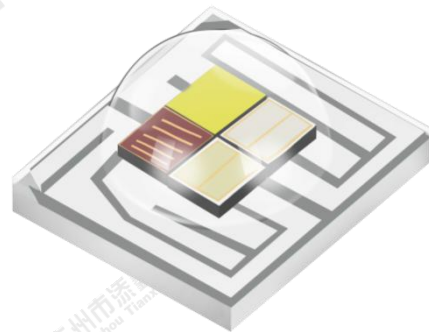


TX-3535RGBW4FC120-OGVCND34-02BH80

PRODUCT SPECIFICATION

Features:

- ◆ Excellent transiting heat from LED chip operating under 400mA
- ◆ High luminous output
- ◆ No UV



Chip Material:

- ◆ Red: AlGaInP
- ◆ Green: GaInN
- ◆ Blue: GaInN
- ◆ White: GaInN

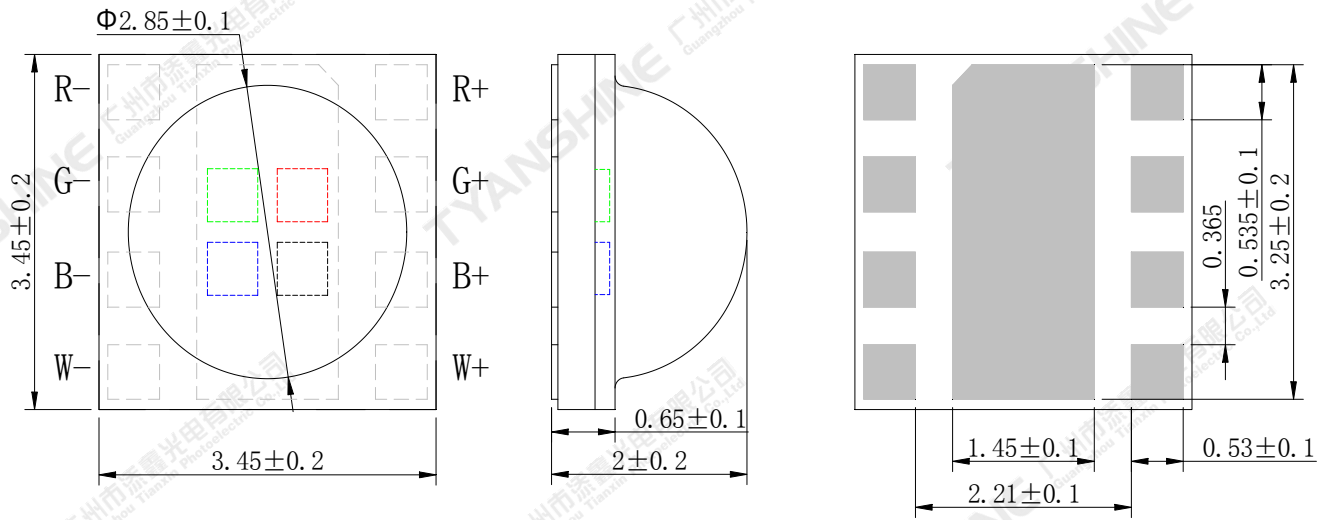
Emitting Color:

- ◆ Red
- ◆ Green
- ◆ Blue
- ◆ White

Applications:

- ◆ Portable flashlight
- ◆ Garden lighting
- ◆ General lighting

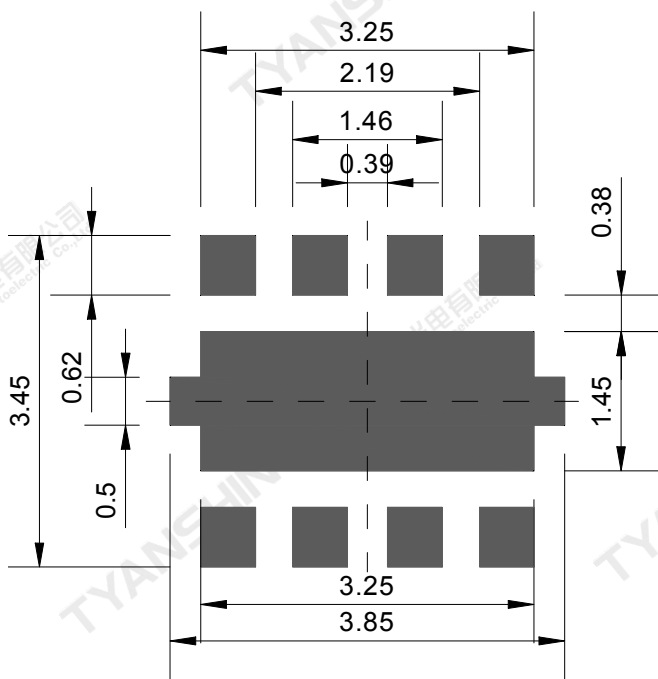
Package Dimensions:



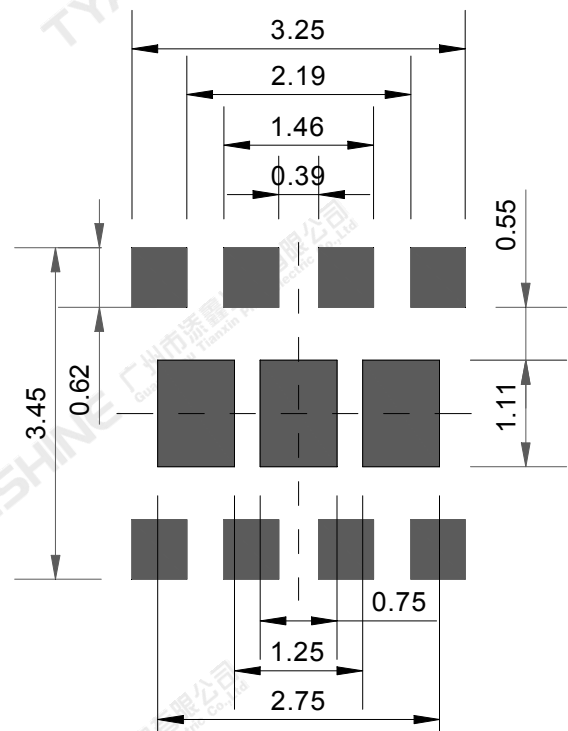
Top view

Side view

Bottom view



Recommended solder pad



Recommended stencil pattern

Notes:

1. All dimensions are in millimeters .
2. Tolerances unless otherwise mentioned are ± 0.1 mm .

Absolute Maximum Ratings (Tc=25°C)

Parameter	Symbol	Max Ratings	Unit	
Forward Current	IF	400	mA	
Reverse Voltage	V _R	Not designed for reverse operation	V	
Power Dissipation	P _D	R	875	mW
		G	1260	
		B	1260	
		W	1190	
Junction Temperature	T _j	R	115	°C
		G	150	
		B	150	
		W	150	
Electrostatic Discharge Threshold (ESD)	ESD	2000	V	
Storage Temperature	T _{stg}	-40~70	°C	
Operation Temperature	T _{opr}	-30~100		

Notes:

- Specifications are subject to change without notice.
- The data on this specification is for reference only and the actual data is in accordance with the acknowledgment.
- Precautions for ESD:
STATIC SHIELD Electricity and surge damages the LED. It is recommended to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.

Electrical Optical Characteristics (Tc=25°C)

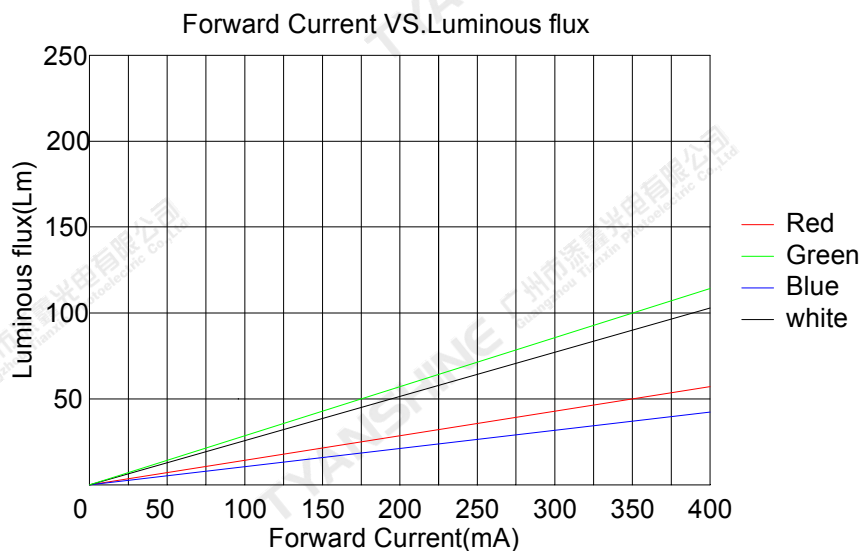
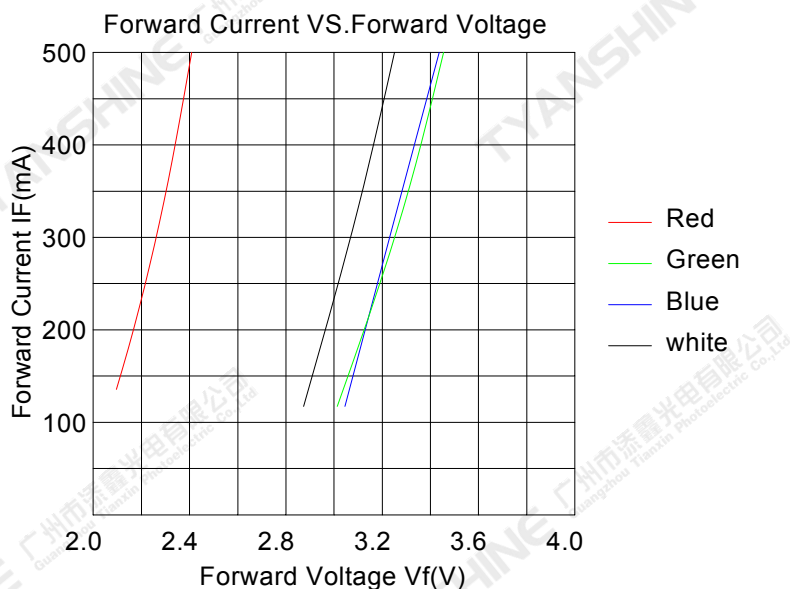
Parameter	Symbol	Condition	Emitting Color	Min.	Typ.	Max.	Units
Luminous Flux	Φ_v	If=350mA	R	40	50	65	lm
			G	80	100	120	
			B	25	34	45	
			W	75	90	105	
Dominant Wavelength	λ_d		R	618	623	628	nm
			G	520	528	535	
			B	460	468	475	
Correlated Colour Temperature	CCT		W	3650	4000	4300	K
			W	5500	6000	6500	
Color Rendering Index	Ra		W	80	85	—	—
Peak-emission Wavelength	λ_p		R	625	630	635	nm
			G	516	525	530	
			B	456	465	471	
Spectral Line Half-Width	$\Delta\lambda$		R	15	20	25	nm
			G	30	35	40	
			B	20	25	30	
		W	20	25	30		
Forward Voltage	V_f	R	2.0	2.3	2.6	V	
		G	3.0	3.3	3.6		
		B	3.0	3.3	3.6		
		W	2.9	3.1	3.4		
Reverse Current	I_R	R	—	—	5	μA	
		G	—	—	5		
		B	—	—	5		
		W	—	—	5		
Viewing Angle at 50% IV	$2\theta_{1/2}$	—	—	120	—	Deg	
Thermal Resistance Junction to Case	$R\theta_{J-C}$	R	—	14	—	K/W	
		G	—	14	—		
		B	—	14	—		
		W	—	14	—		
Temperature Coefficient of Voltage	$V\Delta F/T$	R	—	-2.0	—	mV/°C	
		G	—	-5.8	—		
		B	—	-1.6	—		
		W	—	-1.6	—		

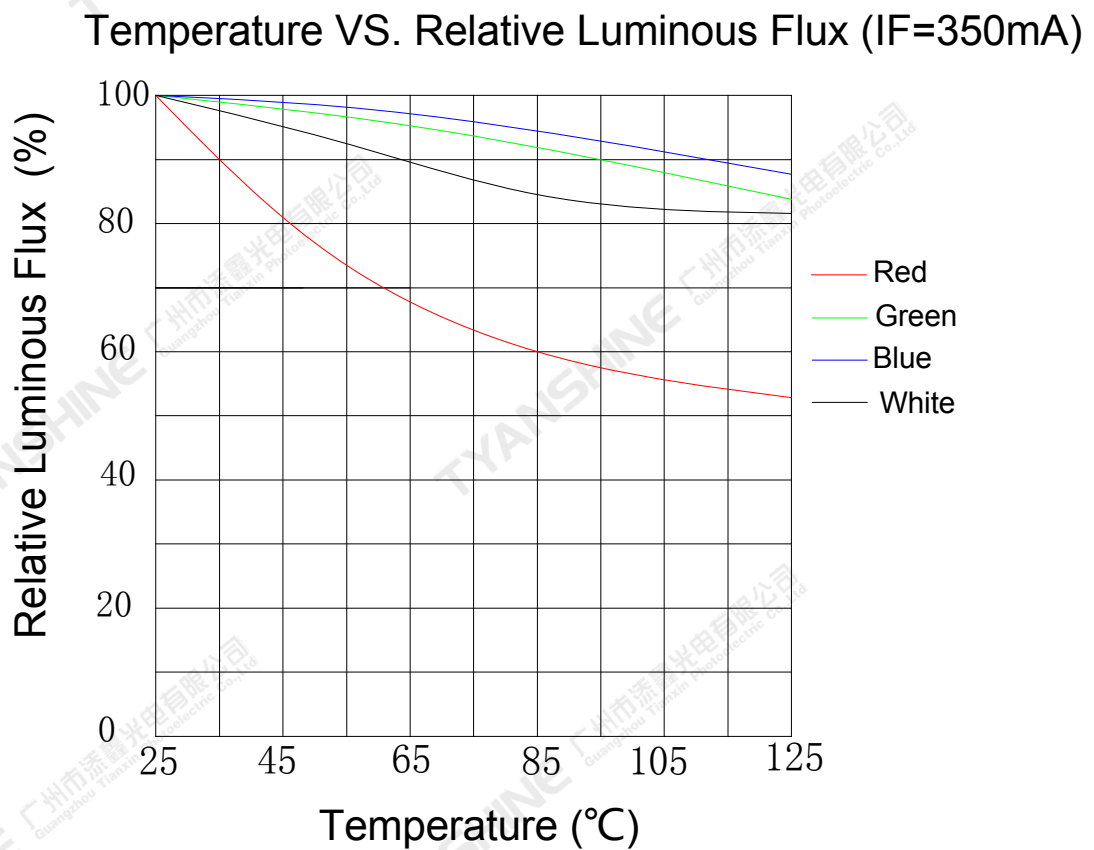
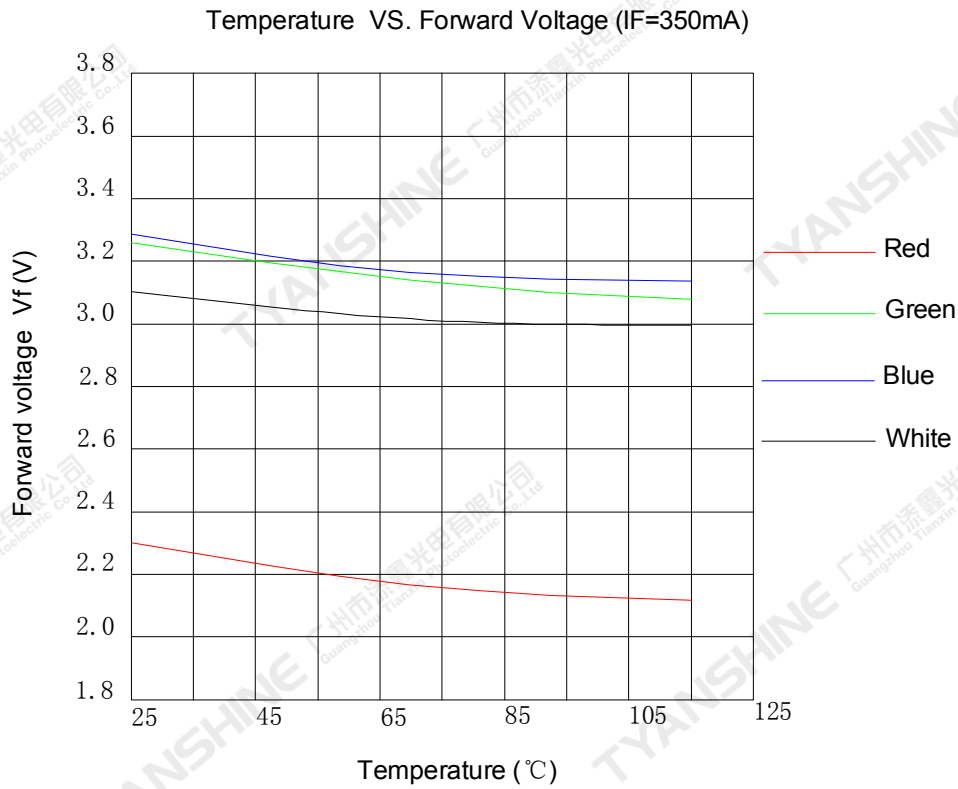
Notes:

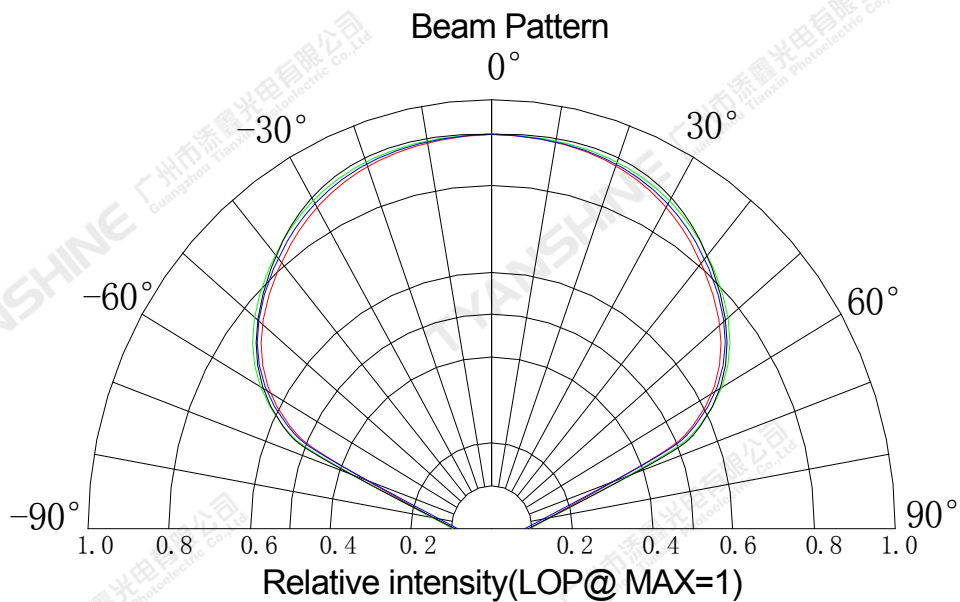
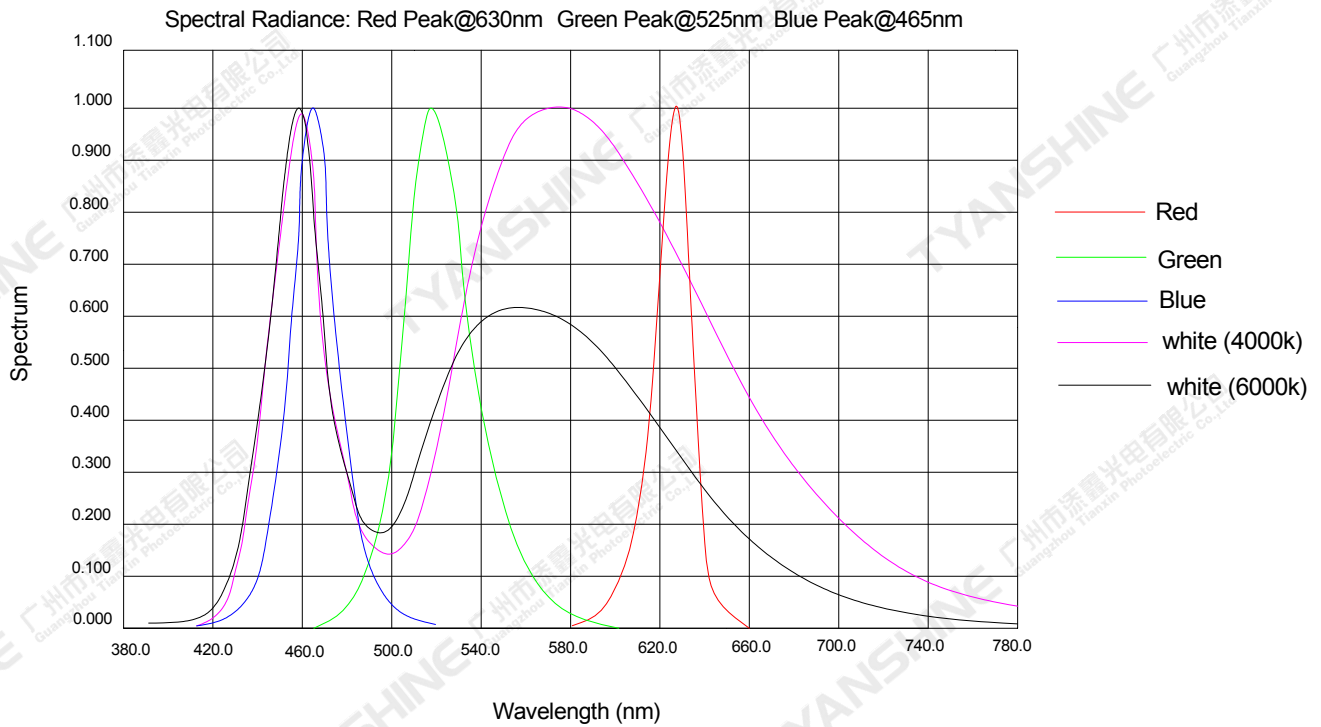
- 1.Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3.The dominant wavelength (λ_d) is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
- 4.Luminous flux measurement tolerance: $\pm 15\%$.
- 5.Forward voltage measurement tolerance: $\pm 0.15V$

Typical Electrical/Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)







Notes:

1. $2\theta_{1/2}$ is the off axis angle from lamp centerline where the luminous intensity is 1/2 of the peak value.
2. View angle tolerance is $\pm 5^\circ$.

Usage Precautions

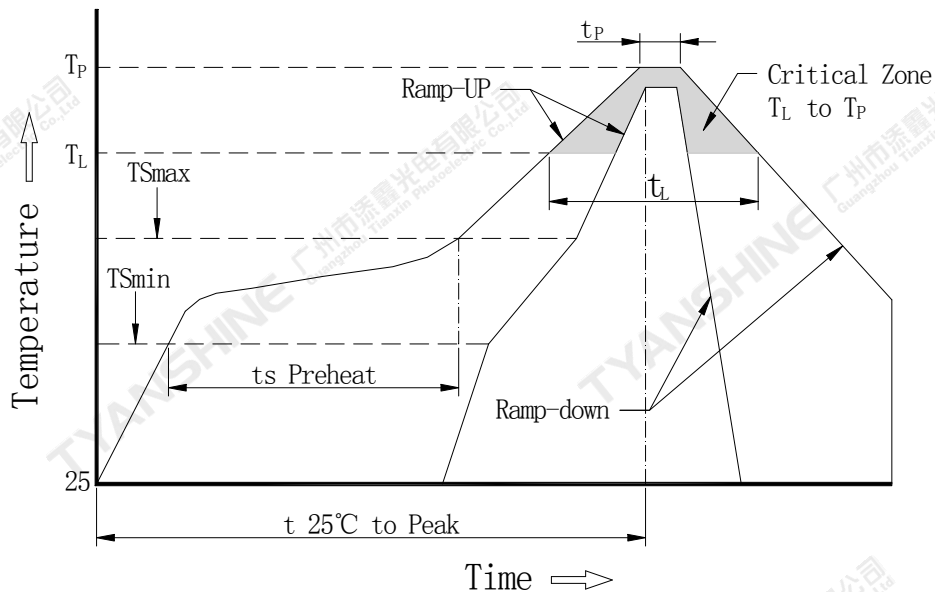
Storage Environment Condition

Temperature: 5°C ~ 30°C (41°F ~ 86°F)

Humidity: 60% RH Max.

Soldering Condition

Use the conditions shown to the under figure.



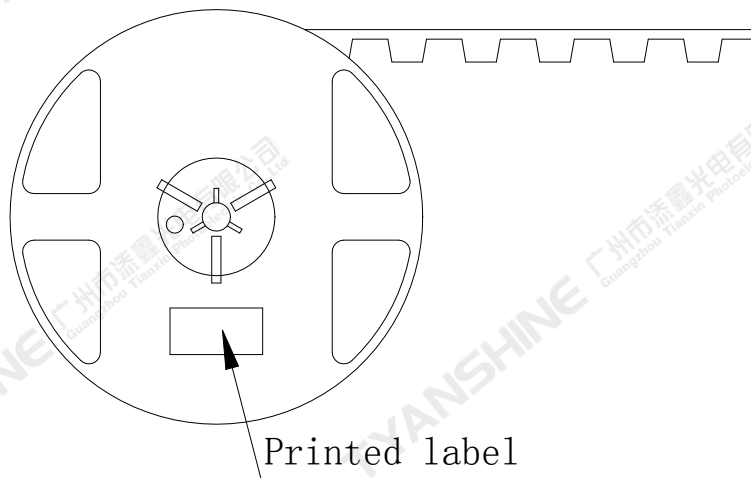
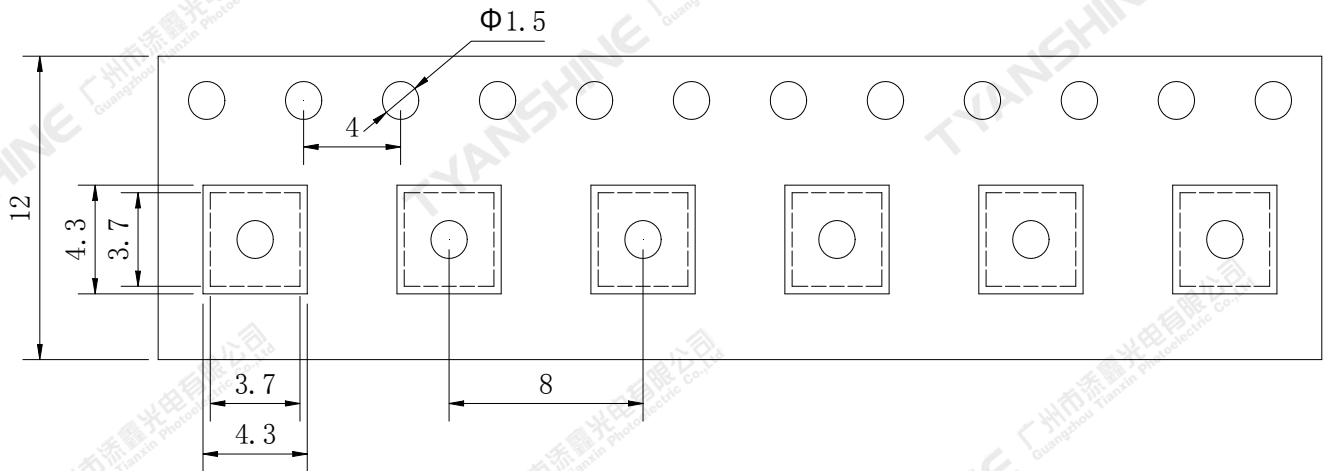
Profile Feature	Lead-Based Solder
Average Ramp-Up Rate (T_{Smax} to T_P)	3°C/second max.
Preheat: Temperature Min (T_{Smin})	100°C
Preheat: Temperature Max (T_{Smax})	150°C
Preheat: Time (T_{Smin} to T_{Smax})	60-120 seconds
Time Maintained Above: Temperature (T_L)	183°C
Time Maintained Above: Time (T_L)	60-150 seconds
Peak/Classification Temperature (T_P)	225°C
Time Within 5°C of Actual Peak Temperature (T_P)	10-30 seconds
Ramp-Down Rate	6°C/second max.
Time 25°C to Peak Temperature	6 minutes max.

Note:

All temperatures refer to topside of the package, measured on the package body surface.

Dimensions For Cannulation And Packaging

Quantity: 1000PCS



Notes:

1. All dimensions are in millimeters.
2. Tolerances are ± 2.0 mm unless otherwise noted.
3. The products are packaged together with silica gel, Transport, not to the weight of welding LED light-emitting area, As a result of the weight of LED light-emitting zone in the quality of, Irresponsible of the Company.